TEL

Docket No. AMENDMENT TRANSMITTAL LETTER SON-2563 Filing Date Art Unit Application No. Examiner 2812 10/501,155-Conf. #5207 July 13, 2004 Not Yet Assigned Applicant(s): Koichiro Saga SURFACE TREATMENT METHOD, SEMICONDUCTOR DEVICE, METHOD OF Invention: FABRICATIN SEMICONDUCTOR DEVICE, AND TREATMENT APPARATUS TO THE COMMISSIONER FOR PATENTS Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below. **CLAIMS AS AMENDED** Claims Highest Remaining Number Number Previously Extra Claims After **Amendment** Paid Present Rate **Total Claims** 41 41 Independent 13 13 Х Claims Multiple Dependent Claims (check if applicable) Other fee (please specify): TOTAL ADDITIONAL FEE FOR THIS AMENDMENT: 0.00 **Small Entity** x Large Entity x No additional fee is required for this amendment. Please charge Deposit Account No. in the amount of \$ A duplicate copy of this sheet is enclosed. A check in the amount of \$ to cover the filing fee is enclosed. Payment by credit card. Form PTO-2038 is attached. x | The Director is hereby authorized to charge and credit Deposit Account No. 18-0013 as described below. A duplicate copy of this sheet is enclosed. Creditany overpayment. Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17. Dated: June 22, 2005 Ronald P/Kananen Attorney/Reg. No.: 24,104 RADER, FISHMAN & GRAUER PLLC 123/3/20th Street, N.W. Sulte 501

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Docket No.: SON-2563

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Koichiro Saga

Application No.: 10/501,155

Filed: July 13, 2004

For: SURFACE TREATMENT METHOD,

SEMICONDUCTOR DEVICE, METHOD OF FABRICATING SEMICONDUCTOR DEVICE,

AND TREATMENT APPARATUS

Confirmation No.: 5207

Art Unit: 2812

Examiner: Not Yet Assigned

FIRST PRELIMINARY AMENDMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to examination on the merits, please amend the above-identified U.S. patent application as follows: